

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the PATENT application of

T.L. Ritzdorf et al

Serial No.: 09/880,715

Filed: June 12, 2001



Examiner: Leader

Group Art Unit: 2823

For: Method for Filling Recessed Micro-Structures with Metallizations in the
Production of a Microelectronic Device

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JUL 06 2004

TECH CENTER 2600

PETITION FOR EXTENSION OF TIME

Mail Stop: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby petitions that any and all extensions of the term necessary to
render timely the filing of the accompanying response be granted.

Enclosed is Credit Authorization Form PTO-2038 in the amount of \$950.00; in
payment of the three month extension of time. The Commissioner is hereby authorized
to charge any other fee due with this paper to Deposit Account No. 50-2449.

Respectfully submitted,

Robert H. Epstein
Registration No. 24,353

07/01/2004 CCHAU1 00000183 09880715
01 FC:1253 950.00 DP

Epstein & Gerken
1901 Research Blvd., Suite 340
Rockville, Maryland 20850
(301) 610-7634

Hand-delivered: 6/30/04